SN54ACT240, SN74ACT240 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS SCAS515B – JUNE 1995 – REVISED MAY 1996

- Inputs Are TTL Compatible
- EPIC[™] (Enhanced-Performance Implanted CMOS) 1-µm Process
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), and Flat (W) Packages, Ceramic Chip Carriers (FK), and Plastic (N) and Ceramic (J) DIPs

description

These octal buffers and line drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

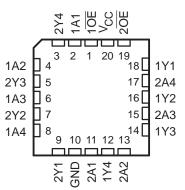
The 'ACT240 are organized as two 4-bit buffers/drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes inverted data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

The SN54ACT240 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74ACT240 is characterized for operation from -40° C to 85°C.

SN54ACT240 J OR W PACKAGE									
SN74ACT240DB, DW, N, OR PW PACKAGE									
(TOP VIEW)									

	(IOP	VIEVV)	
1OE [1A1 [2Y4 [1A2 [2Y3 [1A3 [2Y2 [1A4 [1 2 3 4 5 6 7 8	18 17 16 15 14 13	V _{CC} 20E 1Y1 2A4 1Y2 2A3 1Y3 2A2
2Y1 [9	12] 1Y4
2Y1 [9] 1Y4
GND [10	11	2A1

SN54ACT240 . . . FK PACKAGE (TOP VIEW)



FUNCTION TABLE
(each buffer)

INPU	JTS	OUTPUT
OE	Α	Y
L	Н	L
L	L	н
Н	Х	Z



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

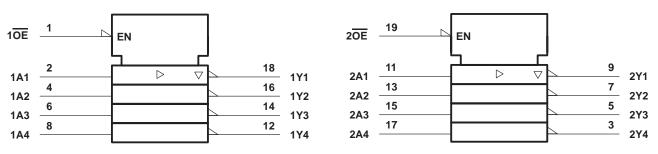


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SN54ACT240, SN74ACT240 **OCTAL BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS

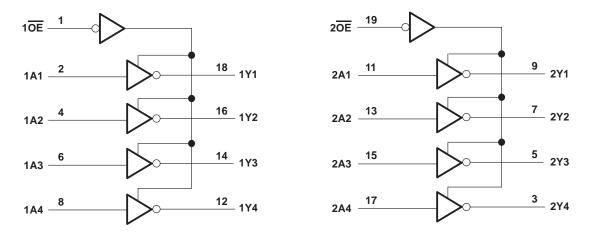
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, V _I (see Note 1)		\ldots –0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)		\ldots –0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)		±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)		±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$		±50 mA
Continuous current through V _{CC} or GND		±200 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2):	DB package	0.6 W
	DW package	1.6 W
	N package	1.3 W
	PW package	0.7 W
Storage temperature range, T _{stg}		–65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.



recommended operating conditions (see Note 3)

		SN54ACT240		0 SN74ACT240		UNIT
		MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
VIL	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	VCC	0	VCC	V
VO	Output voltage	0	VCC	0	VCC	V
ЮН	High-level output current		-24		-24	mA
IOL	Low-level output current		24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	8	0	8	ns/V
Т _А	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vcc	T	A = 25°0	;	SN54A	CT240	SN74A	CT240	UNIT
PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	10.00 FO.00	4.5 V	4.4	4.49		4.4		4.4		
	I _{OH} = -50 μA	5.5 V	5.4	5.49		5.4		5.4		
Vari	lo: - 24 mA	4.5 V	3.86			3.7		3.76		V
VOH	$I_{OL} = -24 \text{ mA}$	5.5 V	4.86			4.7		4.76		v
	I _{OH} = -50 mA [†]	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85		
	I _{OL} = 50 μA	4.5 V		0.001	0.1		0.1		0.1	v
		5.5 V		0.001	0.1		0.1		0.1	
Ve	I _{OL} = 24 mA	4.5 V			0.36		0.5		0.44	
VOL		5.5 V			0.36		0.5		0.44	
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65			
	I _{OL} = 75 mA [†]	5.5 V							1.65	
I _{OZ}	$V_{O} = V_{CC}$ or GND	5.5 V			±0.25		±5		±2.5	μA
lj	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			±0.1		±1		±1	μA
ICC	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			4		80		40	μA
∆I _{CC} ‡	One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V		0.6			1.6		1.5	mA
Ci	$V_{I} = V_{CC} \text{ or } GND$	5 V		2.5						pF
Co	$V_{I} = V_{CC} \text{ or } GND$	5 V		8						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.



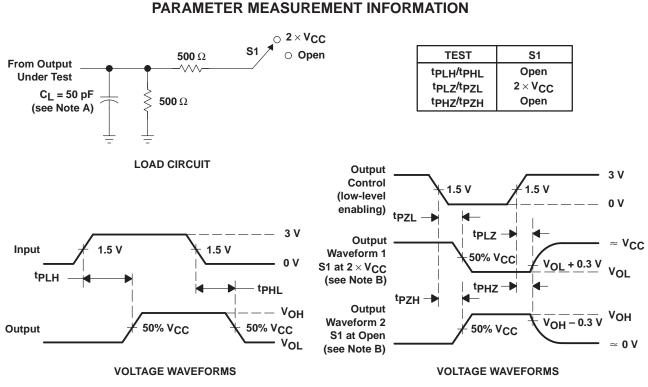
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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Т	ן = 25°C	25°C SN54ACT240		CT240	SN74A	SN74ACT240	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A	v	1.5	6	8.5	1	9.5	1.5	9.5	200
^t PHL		T	1.5	5.5	7.5	1	9	1.5	8.5	ns
^t PZH	6	v	1.5	7	8.5	1	10	1	9.5	
^t PZL	OE	T	2	7	9.5	1	11.5	1.5	10.5	ns
^t PHZ	OE	v	2	8	9.5	1	11	2	10.5	
^t PLZ	UE	ſ	2.5	6.5	10	1	11.5	2	10.5	ns

operating characteristics, V_{CC} = 5 V, T_A = 25° C

PARAMETER		TEST CO	TYP	UNIT	
C _{pd}	Power dissipation capacitance per buffer/driver	C _L = 50 pF,	f = 1 MHz	45	pF



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns. t_f \leq 2.5 ns.

D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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